

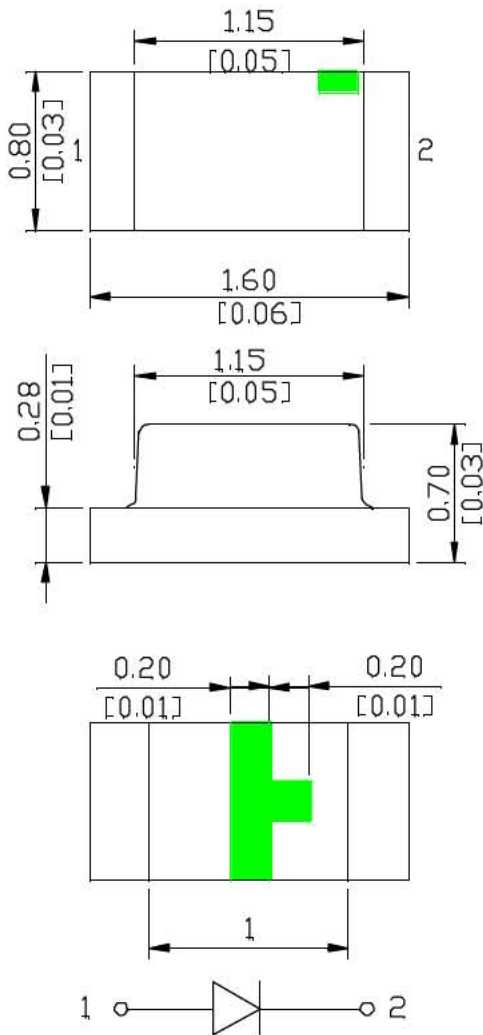
CHIP LED, 0603, Blue/White

Feature

- ◆ Viewing angle:140 deg
- ◆ The materials of the LED dice is InGaN
- ◆ 1.60mm×0.80mm×0.70mm
- ◆ RoHS compliant lead-free soldering compatible

CC-BWB0603DS-DD (JT)

Package Outline



NOTES:

1. All dimensions are in millimeters (inches);
2. Tolerances are $\pm 0.1\text{mm}$ (0.004inch) unless otherwise noted.

Absolute maximum ratings at Ta=25°C

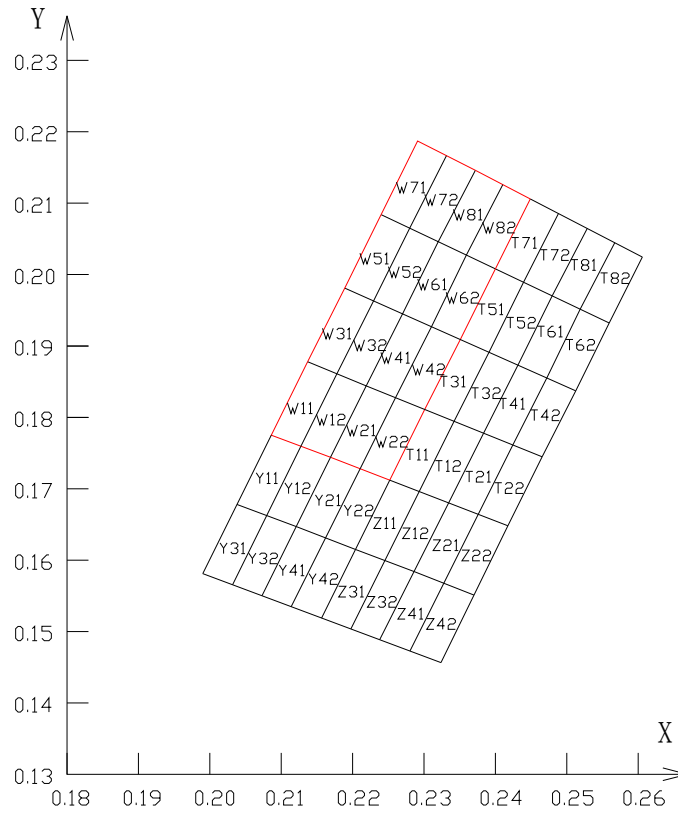
Parameter	Symbol	Value	Unit
Forward current	If	20	mA
Reverse voltage	Vr	5	V
Operating temperature range	Top	-20 ~+85	°C
Storage temperature range	Tstg	-35 ~+85	°C
Peak pulsing current	Ifp	100	mA
Electrostatic Discharge	ESD	1000(HBM)	V

Electro-optical characteristics at Ta=25°C

Parameter	Test Condition	Symbol	Value			Unit			
			Min.	Typ.	Max.				
Forward voltage	If=20mA	Vf	2.7	--	2.8	V			
			2.8	--	2.9	V			
			2.9	--	3.0	V			
			3.0	--	3.1	V			
			3.1	--	3.2	V			
			3.2	--	3.3	V			
			3.3	--	3.4	V			
			3.4	--	3.5	V			
			3.5	--	3.6	V			
			3.6	--	3.7	V			
Luminous intensity	If=20mA	Iv	300	--	350	mcd			
			350	--	400	mcd			
			400	--	450	mcd			
			450	--	500	mcd			
			500	--	550	mcd			
			550	--	600	mcd			
Viewing angle at 50% Iv	If=20mA	2 θ 1/2	--	140	--	Deg			
			Reverse current	Vr=5V	Ir	--	--	10	µA

NOTE: (Tolerance: Iv ±10%, Vf ±0.05V, X,Y ±0.01)
 IFP Conditions: Pulse Width ≤ 10msec. and Duty ≤ 1/10.

Chromaticity Bin



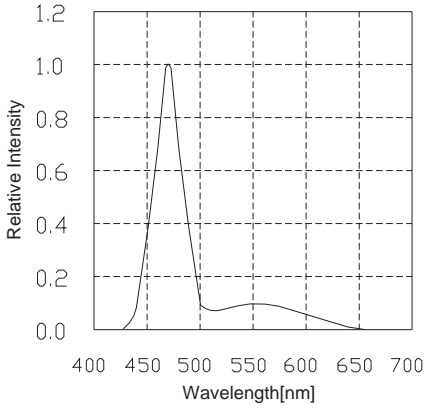
Bin data:

BIN CODE	CIE-X1	CIE-Y1	CIE-X2	CIE-Y2	CIE-X3	CIE-Y3	CIE-X4	CIE-Y4
W11	0.2128	0.1760	0.2086	0.1775	0.2137	0.1878	0.2178	0.1861
W12	0.2169	0.1744	0.2128	0.1760	0.2178	0.1861	0.2219	0.1844
W21	0.2211	0.1728	0.2169	0.1744	0.2219	0.1844	0.2260	0.1828
W22	0.2252	0.1712	0.2211	0.1728	0.2260	0.1828	0.2301	0.1811
W31	0.2178	0.1861	0.2137	0.1878	0.2189	0.1981	0.2230	0.1963
W32	0.2219	0.1844	0.2178	0.1861	0.2230	0.1963	0.2270	0.1945
W41	0.2260	0.1828	0.2219	0.1844	0.2270	0.1945	0.2311	0.1927
W42	0.2301	0.1811	0.2260	0.1828	0.2311	0.1927	0.2351	0.1909
W51	0.2230	0.1963	0.2189	0.1981	0.2240	0.2084	0.2280	0.2065
W52	0.2270	0.1945	0.2230	0.1963	0.2280	0.2065	0.2320	0.2046
W61	0.2311	0.1927	0.2270	0.1945	0.2320	0.2046	0.2360	0.2027
W62	0.2351	0.1909	0.2311	0.1927	0.2360	0.2027	0.2400	0.2008
W71	0.2280	0.2065	0.2240	0.2084	0.2291	0.2187	0.2332	0.2167
W72	0.2320	0.2046	0.2280	0.2065	0.2332	0.2167	0.2372	0.2146
W81	0.2360	0.2027	0.2320	0.2046	0.2372	0.2146	0.2411	0.2126
W82	0.2400	0.2008	0.2360	0.2027	0.2411	0.2126	0.2449	0.2106

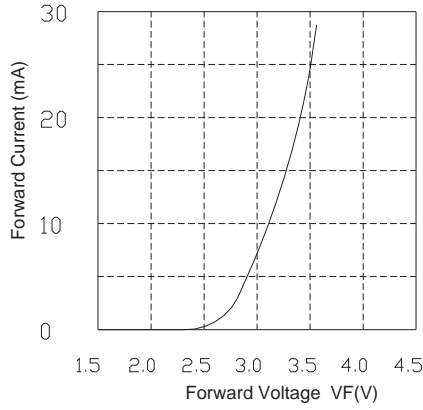
Typical optical characteristics curves

Spectral Distribution

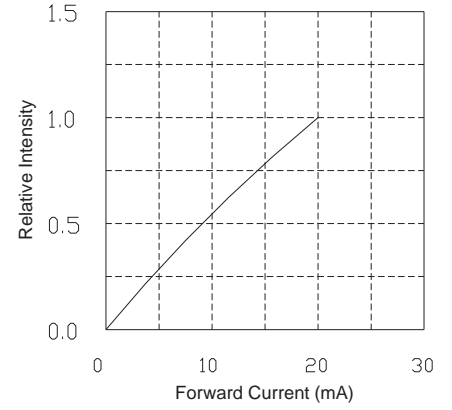
Relative Intensity vs. Wavelength (Ta=25°C)



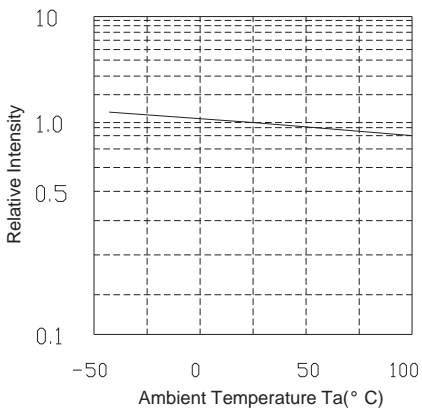
Forward Current vs. Forward Voltage (Ta=25°C)



Relative Intensity vs. Forward Current (Ta=25°C)

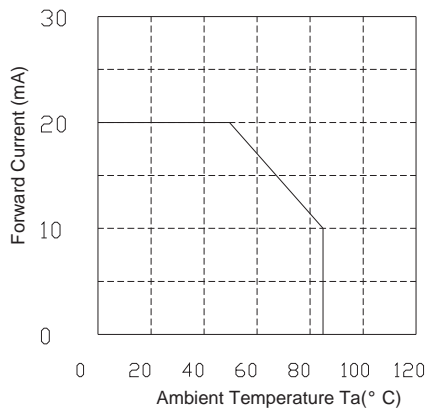


Relative Intensity vs. Ambient Temperature



Derating

Maximum Forward Current vs. Ambient Temperature



Forward Current vs. Chromaticity (Ta=25°C)

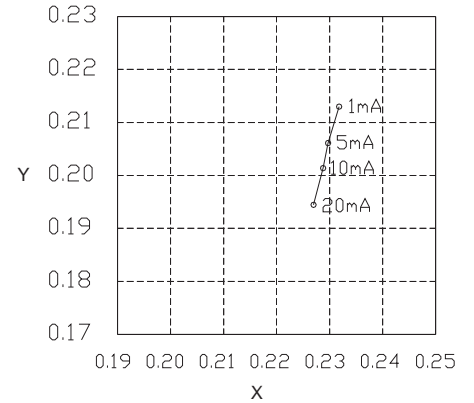
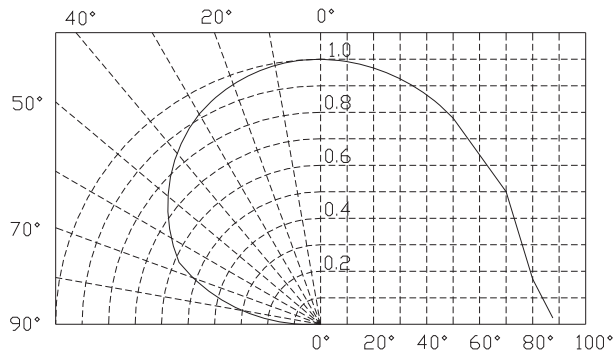


Diagram characteristics of radiation



Reliability

(1) TEST ITEMS AND RESULTS

Type	Test Item	Ref. Standard	Test Conditions	Note	Number of Damaged
Environmental Sequence	Resistance to Soldering Heat(Reflow Soldering)	JESD22-B106	Tsld=260°C,10sec	2 times	0/22
	Temperature Cycle	JESD22-A104	-40°C 30min 25°C↑↓5min 100°C 30min	300 cycle	0/22
	Thermal Shock	JESD22-A106	-35°C 15min ↑↓ 85°C 15min	300 cycle	0/22
	High Temperature Storage	JESD22-A103	T _a =100°C	1000 hrs	0/22
	Low Temperature Storage	JESD22-A119	T _a =-40°C	1000 hrs	0/22
Operation Sequence	Life Test	JESD22-A108	T _a =25°C I _F =20mA	1000 hrs	0/22

(2) CRITERIA FOR JUDGING THE DAMAGE

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	VF	IF=20mA	-	U.S.L*)×1.1
Reverse Current	IR	VR=5V	-	U.S.L*)×2.0
Luminous Intensity	IV	IF=20mA	L.S.L**)×0.5	-

U.S.L.: Upper Standard Level

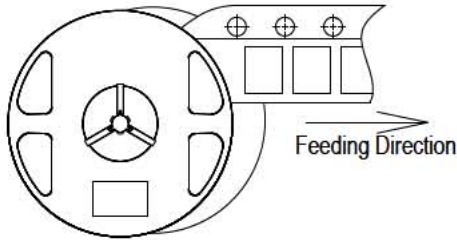
L.S.L.: Lower Standard Level

NOTES:

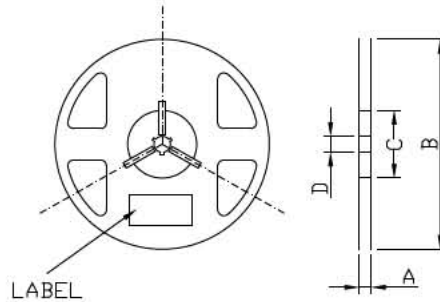
1. Any reliability test standard change is confidential.

Packaging Specifications

● Feeding Direction

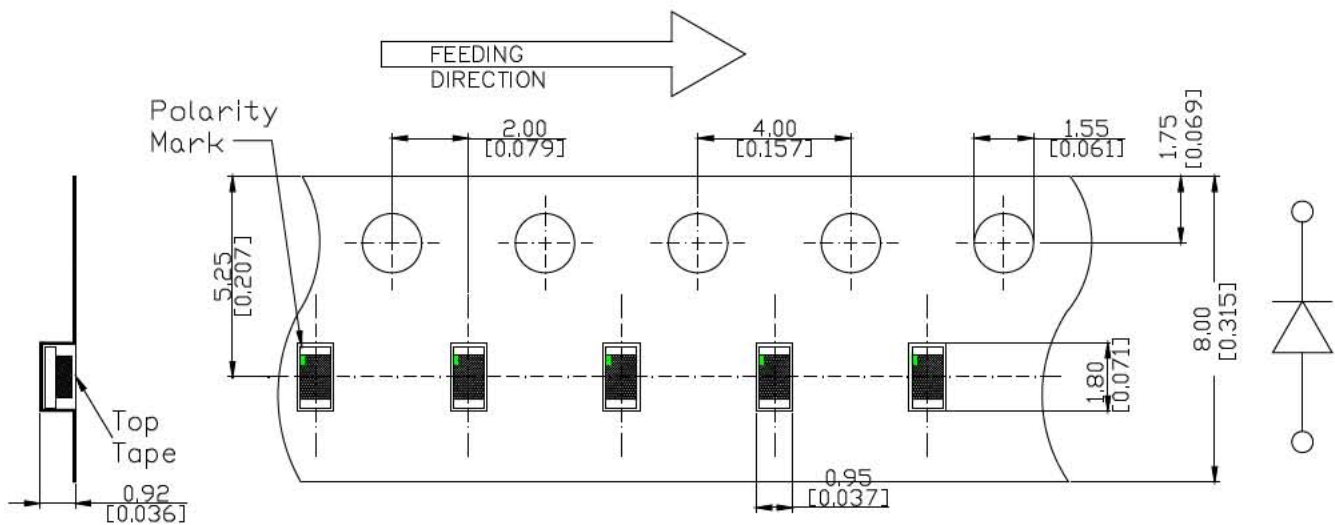


● Dimensions of Reel (Unit: mm)

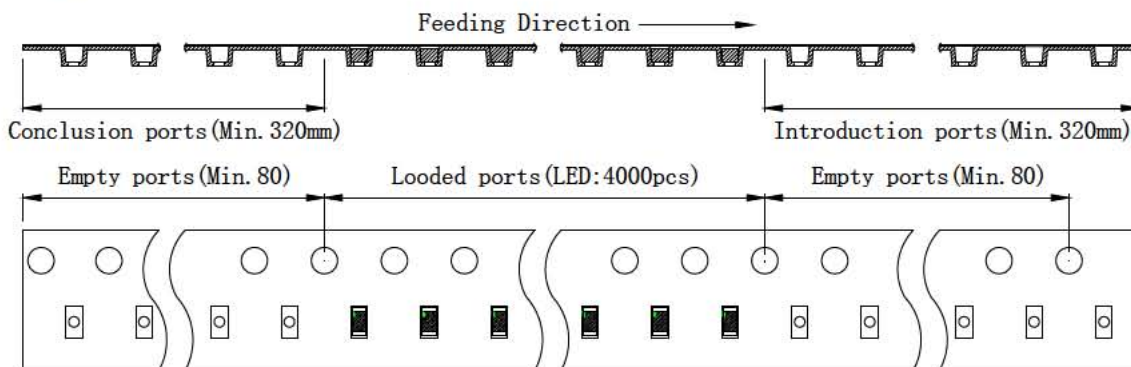


A	8.0 ± 0.1mm
B	178 ± 1mm
C	60 ± 1mm
D	13.0 ± 0.5mm

● Dimensions of Tape (Unit: mm)



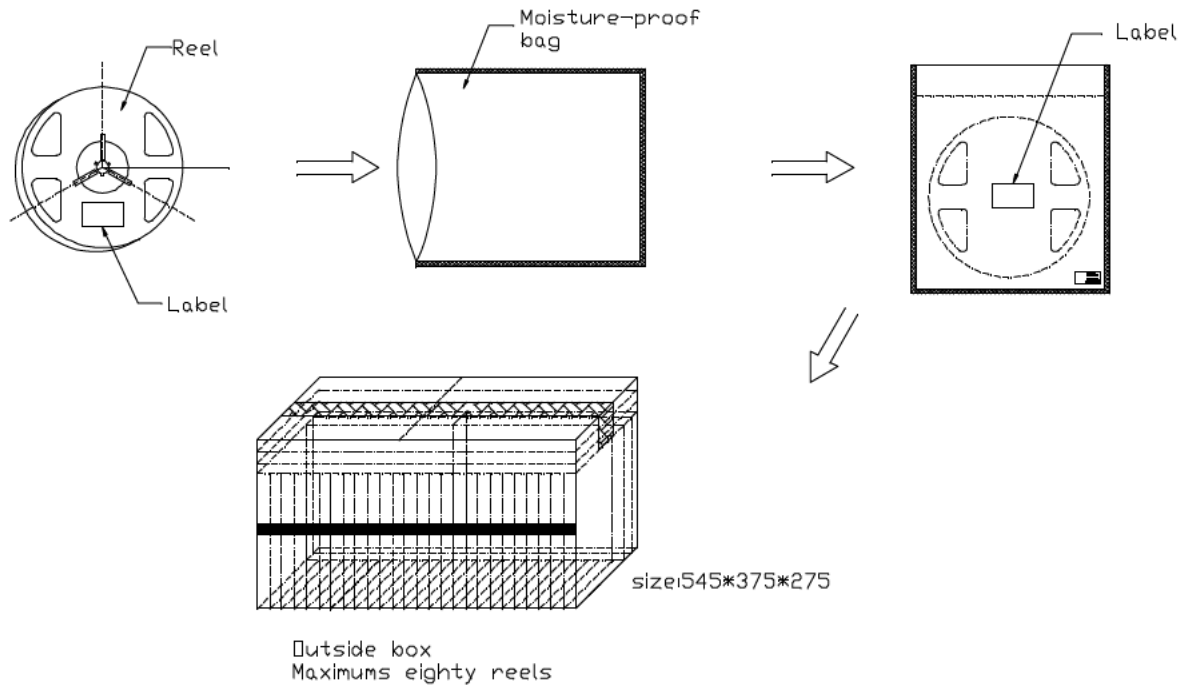
● Arrangement of Tape




NOTES

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 4,000 pcs/ Reel.

Packaging specifications



■ Label

PART NO:	
LOT NO:	
	
BIN CODE:	
IV:	
VF:	
X/Y:	
QTY:	PCS
DATE:	

CAUTIONS

Package specifications

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Eighty moisture-proof bag of maximums are put the outside box (size: about 545mm x about 375mm x about 275mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has two steps.

Storage conditions

Before opening the package:

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material is recommended.

After opening the package:

The LEDs should be kept at 30°C or less and 50%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material. It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.